

# N-Channel JFET



## J210 – J212 / SSTJ210 – SSTJ212

### FEATURES

- Low Noise
- Low Leakage
- High Power Gain

### APPLICATIONS

- General Purpose Amplifiers
- VHF/UHF Amplifiers
- Mixers
- Oscillators

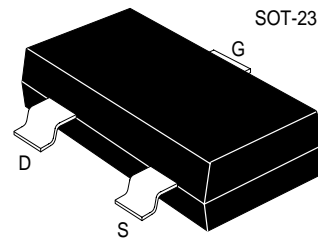
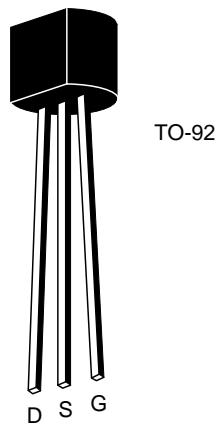
### DESCRIPTION

The J210 Series is an N-Channel JFET single device encapsulated in a TO-92 plastic package well suited for automated assembly. The device features low leakage, typically under 2 pA, low noise, under 10 nano volts per square hertz at 10 hertz and high gain. This series is excellent for mixer, oscillators and amplifier applications.

### ORDERING INFORMATION

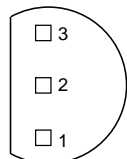
Part	Package	Temperature Range
J210-11	Plastic TO-92 Package	-55°C to +135°C
SSTJ210-11	Plastic SOT-23	-55°C to +135°C

### PIN CONFIGURATION



CJ1

- 1 DRAIN
- 2 SOURCE
- 3 GATE



BOTTOM VIEW

### PRODUCT MARKING (SOT-23)

SSTJ210	Z10
SSTJ211	Z11
SSTJ212	Z12

**ABSOLUTE MAXIMUM RATINGS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Parameter/Test Condition	Symbol	Limit	Unit
Gate-Drain Voltage	$V_{GD}$	-25	V
Gate-Source Voltage	$V_{GS}$	-25	V
Gate Current	$I_G$	10	mA
Power Dissipation	$P_D$	360	mW
Power Derating		3.27	mW/ $^\circ\text{C}$
Operating Junction Temperature	$T_J$	-55 to 135	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to 150	$^\circ\text{C}$
Lead Temperature (1/16" from case for 10 seconds)	$T_L$	300	$^\circ\text{C}$

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

SYMBOL	CHARACTERISTICS	TYP <sup>1</sup>	210		211		212		UNIT	TEST CONDITIONS
			MIN	MAX	MIN	MAX	MIN	MAX		
<b>STATIC</b>										
$V_{(BR)GSS}$	Gate-Source Breakdown Voltage	-35	-25		-25		-25		V	$I_G = -1\mu\text{A}, V_{DS} = 0\text{V}$
$V_{GS(OFF)}$	Gate-Source Cut off Voltage		-1	-3	-2.5	-4.5	-4	-6		$V_{DS} = 15\text{V}, I_D = 1\text{nA}$
$I_{DSS}$	Saturation Drain Current <sup>2</sup>		2	15	7	20	15	40	mA	$V_{DS} = 15\text{V}, V_{GS} = 0\text{V}$
$I_{GSS}$	Gate Reverse Current	-1		-100		-100		-100	pA	$V_{GS} = -15\text{V}, V_{DS} = 0\text{V}$
		-0.5							nA	$T_A = 125^\circ\text{C}$
$I_G$	Gate Operating Current	-1							pA	$V_{DG} = 10\text{V}, I_D = 1\text{mA}$
$I_{D(OFF)}$	Drain Cutoff Current	1							pA	$V_{DS} = 10\text{V}, V_{GS} = -8\text{V}$
$V_{GS(F)}$	Gate-Source Forward Voltage	0.7							V	$I_G = 1\text{mA}, V_{DS} = 0\text{V}$
<b>DYNAMIC</b>										
$g_{fs}$	Common-Source Forward Transconductance		4	12	6	12	7	12	mS	$V_{DS} = 15\text{V}, V_{GS} = 0\text{V}$ $f = 1\text{kHz}$
$g_{os}$	Common-Source Output Conductance			150		200		200	$\mu\text{S}$	
$C_{iss}$	Common-Source Input Capacitance	4							pF	$V_{DS} = 15\text{V}, V_{GS} = 0\text{V}$ $f = 1\text{MHz}$
$C_{rss}$	Common-Source Reverse Transfer Capacitance	1.5								
$\bar{e}_n$	Equivalent Input Noise Voltage	5							nV/ $\sqrt{\text{Hz}}$	$V_{DS} = 15\text{V}, V_{GS} = 0\text{V}$ $f = 1\text{kHz}$

- NOTES: 1. For design aid only, not subject to production testing.  
 2. Pulse test; PW = 300 $\mu\text{s}$ , duty cycle  $\leq 3\%$ .